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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/539,691	03/31/2000	Takahiro Yamamoto	P/1071-1009	1017	
2352	7590 03/12/2003				
OSTROLENK FABER GERB & SOFFEN			EXAMI	EXAMINER	
1180 AVENUE OF THE AMERICAS NEW YORK, NY 100368403			STAICOVICI, STEFAN		
			ART UNIT	PAPER NUMBER	
			1732	714	
			DATE MAILED: 03/12/2003		

Please find below and/or attached an Office communication concerning this application or proceeding.

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*	Application No.	Applicant(s)			
Office Action Comment	09/539,691	YAMAMOTO ET	AL.		
Office Action Summary	Examiner	Art Unit			
	Stefan Staicovici	1732			
The MAILING DATE of this communication app Period for Reply	ears on the cover s	heet with the corresp ndence ac	idress		
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). Status	36(a). In no event, however within the statutory minimularill apply and will expire SIX cause the application to be	r, may a reply be timely filed um of thirty (30) days will be considered timel (6) MONTHS from the mailing date of this cecome ABANDONED (35 U.S.C. § 133).			
1) Responsive to communication(s) filed on 20 F	ebruary 2003 .				
2a) ☐ This action is FINAL . 2b) ☑ Thi	is action is non-fina	l.			
3) Since this application is in condition for allowa closed in accordance with the practice under a Disposition of Claims			ne merits is		
4) Claim(s) 5-10 is/are pending in the application	ı .				
4a) Of the above claim(s) is/are withdraw	vn from considerati	on.			
5) Claim(s) is/are allowed.					
6)⊠ Claim(s) <u>5-10</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers					
9) ☐ The specification is objected to by the Examiner	r.				
10) The drawing(s) filed on 13 March 2000 is/are: a) ⊠ accepted or b) objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
11) $oxed{oxed}$ The proposed drawing correction filed on <u>June 19, 2000</u> is: a) $oxed{oxed}$ approved b) $oxed{oxed}$ disapproved by the Examiner.					
If approved, corrected drawings are required in reply to this Office action.					
12) The oath or declaration is objected to by the Exa	aminer.				
Priority under 35 U.S.C. §§ 119 and 120					
13) Acknowledgment is made of a claim for foreign	priority under 35 L	J.S.C. § 119(a)-(d) or (f).			
a) ☐ All b) ☐ Some * c) ☐ None of:					
 Certified copies of the priority documents 	s have been receive	∍d.			
2. Certified copies of the priority documents	s have been receive	ed in Application No			
 3. Copies of the certified copies of the prior application from the International Bur * See the attached detailed Office action for a list of the certified copies of the prior application. 	reau (PCT Rule 17.	2(a)).	Stage		
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).					
 a) The translation of the foreign language pro 15) Acknowledgment is made of a claim for domesti 	• •				
Attachment(s)					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) 🔲 N	terview Summary (PTO-413) Paper No otice of Informal Patent Application (PT ther:			

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DETAILED ACTION

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Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set

forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this

application is eligible for continued examination under 37 CFR 1.114, and the fee set

forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action

has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on February

20, 2003 (Paper No. 22) has been entered.

Response to Amendment

2. Applicants' amendment filed January 2, 2003 (Paper No. 19) has been entered.

Claims 8-10 have been amended. Claims 1-4 and 15-18 have been canceled. No new

claims have been added. Claims 5-10 are pending in the instant application.

3. In view of Applicants' Supplemental Request for Reconsideration filed February

20, 2003 (Paper No. 22) the rejections over US Patent No. 6,172,330 has been

withdrawn.

Claim Rejections - 35 USC § 103

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all

obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the

invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

5. Claims 5, 7-8 and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nakazawa et al. (US Patent No. 5,948,200) in view of Funami et al. (US Patent No. 5,055,653).

Nakazawa et al. ('200) teach the basic claimed process of machining a plurality of holes (feed-through holes) (SH) in a ceramic green sheet (5) including, providing a pulsed laser beam from a laser source (7), passing said laser beam through a transparent mask (8) (diffraction grating) to form a plurality of beams (see col. 7, lines 30-35), reflecting said plurality of beams off a galvano-mirror (9) having two degrees of freedom and simultaneously irradiating said ceramic green sheet (5) to form a plurality of holes (feed-through holes) (SH) (see col. 7, lines 3-35 and Figure 4). Further, Nakazawa et al. ('200) teach that said galvano-mirror (9) continuously changes the position of said beam by continuously changing the reflection angle in two directions (X,Y) (see col. 19, lines 8-16 and col. 20, lines 8-17) (repeatedly irradiating the ceramic green sheet...changing reflection angle of the galvano-scan mirror). Furthermore, it is submitted that in view of Applicants' remarks on page 3 of the amendment filed June 6, 2002 (Paper No. 12) that a "diffraction grating uses a large number of parallel closely spaced slits which provides a plurality of output light beams" said transparent mask (8) Nakazawa et al. ('200) is a "diffraction grating."

Regarding claim 5, Nakazawa et al. ('200) do not teach using converging lens to individually converge said plurality of beams. Funami et al. ('653) teach a laser process

including, providing a laser beam (2e), splitting said laser by beam splitter (13) (forming a plurality of laser beams) and converging said plurality of laser beams (2f) using a convergent lenses (11) (see Figure 9 and col. 6, line 65 through col. 7, line 4). Therefore, it would have been obvious for one of ordinary skill in the art to have provided converging lenses for individually converging a plurality of laser beams as taught by Funami *et al.* ('653) in the process of Nakazawa *et al.* ('200) because, Funami *et al.* ('653) specifically teaches that such lenses provide equal laser energy densities at the machining spots, hence obtaining holes having a uniform size and shape.

In regard to claim 7, Nakazawa *et al.* ('200) teach the use of a positioning table (35) that moves said green sheet during laser processing (see col. 17, lines 27-36).

Specifically regarding claim 8, Nakazawa *et al.* ('200) teach passing said laser beam through a transparent mask (8) (diffraction grating) to form a plurality of beams (see col. 7, lines 30-35).

Regarding claim 10, Nakazawa *et al.* ('200) teach the use of a carrier film (1) (BF) (see Figure 4 and col. 7, lines 3-8).

6. Claims 5, 7-8 and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nakazawa et al. (US Patent No. 5,948,200) in view of JP 10-034365 and in further view of Funami et al. (US Patent No. 5,055,653).

Nakazawa et al. ('200) teach the basic claimed process of machining a plurality of holes (feed-through holes) (SH) in a ceramic green sheet (5) including, providing a pulsed laser beam from a laser source (7), passing said laser beam through a transparent

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mask (8) (diffraction grating) to form a plurality of beams (see col. 7, lines 30-35), reflecting said plurality of beams off a galvano-mirror (9) having two degrees of freedom and simultaneously irradiating said ceramic green sheet (5) to form a plurality of holes (feed-through holes) (SH) (see col. 7, lines 3-35 and Figure 4). Further, Nakazawa *et al.* ('200) teach that said galvano-mirror (9) continuously changes the position of said beam by continuously changing the reflection angle in two directions (X,Y) (see col. 19, lines 8-16 and col. 20, lines 8-17) (repeatedly irradiating the ceramic green sheet...changing reflection angle of the galvano-scan mirror).

Regarding claim 5, it is submitted that in view of Applicants' remarks on page 3 of the amendment filed June 6, 2002 (Paper No. 12) that a "diffraction grating uses a large number of parallel closely spaced slits which provides a plurality of output light beams" said transparent mask (8) Nakazawa et al. ('200) is a "diffraction grating." However, in order to address Applicants' concerns the teachings of JP 10-34365 are used to show the use of a phase grating (diffraction grating) to split a laser beam into a plurality of beams. Specifically, JP 10-34365 teaches a process for forming a plurality of holes in a plate using a phase grating (9) (diffraction grating) including, providing a laser beam, reflecting said laser beam off galvano-mirror (5) having two degrees of freedom and dividing said beam into a plurality of beams using said phase grating (9) (diffraction grating). Therefore, it would have been obvious for one of ordinary skill in the art to have provided a phase grating (diffraction grating) as taught by JP 10-34365 in the process of Nakazawa et al. ('200) because Nakazawa et al. ('200) teaches the use of a beam splitter

to obtain multiple beams, whereas JP 10-34365 specifically teaches that a phase grating is preferable for splitting a laser beam. Further regarding claim 5, Nakazawa et al. ('200) in view of JP 10-34365 do not teach using converging lens to individually converge said plurality of beams. Funami et al. ('653) teach a laser process including, providing a laser beam (2e), splitting said laser by beam splitter (13) (forming a plurality of laser beams) and converging said plurality of laser beams (2f) using a convergent lenses (11) (see Figure 9 and col. 6, line 65 through col. 7, line 4). Therefore, it would have been obvious for one of ordinary skill in the art to have provided converging lenses for individually converging a plurality of laser beams as taught by Funami et al. ('653) in the process of Nakazawa et al. ('200) in view of JP 10-34365because, Funami et al. ('653) specifically teaches that such lenses provide equal laser energy densities at the machining spots, hence obtaining holes having a uniform size and shape.

In regard to claim 7, Nakazawa et al. ('200) teach the use of a positioning table (35) that moves said green sheet during laser processing (see col. 17, lines 27-36).

Specifically regarding claim 8, Nakazawa et al. ('200) teach passing said laser beam through a transparent mask (8) (diffraction grating) to form a plurality of beams (see col. 7, lines 30-35). JP 10-34365 teaches a phase grating (9) (diffraction grating) that is transparent to the laser beam. Therefore, it would have been obvious for one of ordinary skill in the art to have provided a phase grating (diffraction grating) as taught by JP 10-34365 in the process of Nakazawa et al. ('200) in view of Funami et al. ('653) because Nakazawa et al. ('200) teaches the use of a beam splitter to obtain multiple

beams, whereas JP 10-34365 specifically teaches that a phase grating is preferable for splitting a laser beam.

Regarding claim 10, Nakazawa et al. ('200) teach the use of a carrier film (1) (BF) (see Figure 4 and col. 7, lines 3-8).

7. Claim 6 is rejected under 35 U.S.C. 103(a) as being unpatentable over JP 10-034365 in view of Nakazawa et al. (US Patent No. 5,948,200) and in further view Funami et al. (US Patent No. 5,055,653).

JP 10-34365 teaches the basic claimed process of forming a plurality of holes in a plate using a phase grating (9) (diffraction grating) including, providing a laser beam, reflecting said laser beam off galvano-mirror (5) having two degrees of freedom and dividing said beam into a plurality of beams using said phase grating (9) (diffraction grating).

Regarding claim 6, JP 10-34365 does not teach a ceramic green sheet and repeatedly irradiating the sheet by changing reflection angle of the galvano-scan mirror. Nakazawa *et al.* ('200) teach laser machining a ceramic green sheet using a laser beam that has been divided into a plurality of beams. Further, Nakazawa *et al.* ('200) teach that a galvano-mirror (9) that continuously changes the position of a laser beam by continuously changing the reflection angle in two directions (X,Y) (see col. 19, lines 8-16 and col. 20, lines 8-17) (repeatedly irradiating the ceramic green sheet...changing reflection angle of the galvano-scan mirror). Therefore, it would have been obvious for one of ordinary skill in the art to have process a ceramic green sheet by continuously

changing the reflection angle in two directions as taught by Nakazawa et al. ('200) using the process of JP 10-34365 because, JP 10-34365 specifically teaches that a phase grating is preferable in dividing a laser beam and that a galvano-mirror is used for reflecting off the laser beam, and also because both references teach similar processes and solve a similar problem of dividing a laser beam into multiple beams to simultaneously drill a plurality of holes. Further regarding claim 6, JP 10-34365 in view Nakazawa et al. ('200) do not teach converging lenses for individually converging the plural laser beams. Funami et al. (653) teach a laser process including, providing a laser beam (2e), splitting said laser by beam splitter (13) (forming a plurality of laser beams) and converging said plurality of laser beams (2f) using a convergent lenses (11) (see Figure 9 and col. 6, line 65 through col. 7, line 4). Therefore, it would have been obvious for one of ordinary skill in the art to have provided converging lenses for individually converging a plurality of laser beams as taught by Funami et al. (653) in the process of JP 10-34365 in view Nakazawa et al. ('200) because, Funami et al. ('653) specifically teaches that such lenses provide equal laser energy densities at the machining spots, hence obtaining holes having a uniform size and shape.

8. Claim 6 is rejected under 35 U.S.C. 103(a) as being unpatentable over Wang (US Patent No. 5,293,025) in view of JP 10-034365 and in further view of Funami *et al.* (US Patent No. 5,055,653).

Wang ('025) teaches the basic claimed process of machining a plurality of holes in a ceramic green sheet (23) (see col. 4, lines 48-58) including, providing a laser beam

from a laser source (3), reflecting said laser beam off galvano-mirrors (11, 15) having two degrees of freedom (X, Y), passing said laser beam through a splitter to form a plurality of beams (see col. 7, lines 1-3) and irradiating said ceramic green sheet (23) to form a plurality of holes (see col. 4, lines 3-30 and Figure 41). Further, Wang ('025) teaches that said galvano-mirrors (11, 15) continuously change the position of said laser beam by continuously changing the reflection angle in two directions (X,Y) (see col. 6, lines 42-63) (repeatedly irradiating the ceramic green sheet...changing reflection angle of the galvano-scan mirror).

Regarding claim 6, although Wang ('025) teaches the use of a beam splitter to obtain multiple beams, Wang ('025) does not specifically teach a diffraction grating. JP 10-34365 teaches a process for forming a plurality of holes in a plate using a phase grating (9) (diffraction grating) including, providing a laser beam, reflecting said laser beam off galvano-mirror (5) having two degrees of freedom and dividing said beam into a plurality of beams using said phase grating (9) (diffraction grating). Therefore, it would have been obvious for one of ordinary skill in the art to have provided a phase grating (diffraction grating) as taught by JP 10-34365 in the process of Wang ('025) because Wang ('025) teaches the use of a beam splitter to obtain multiple beams, whereas JP 10-34365 specifically teaches that a phase grating is preferable in splitting a laser beam. Further regarding claim 6, although Wang ('025) teaches the use of a converging lens and a plurality of laser beams, Wang ('025) in view of JP 10-34365 do not teach converging lenses for individually converging the plural laser beams. Funami et al.('653) teach a

laser process including, providing a laser beam (2e), splitting said laser by beam splitter (13) (forming a plurality of laser beams) and converging said plurality of laser beams (2f) using a convergent lenses (11) (see Figure 9 and col. 6, line 65 through col. 7, line 4). Therefore, it would have been obvious for one of ordinary skill in the art to have provided converging lenses for individually converging a plurality of laser beams as taught by Funami *et al.*('653) in the process of Wang ('025) in view of JP 10-34365 because, Funami *et al.*('653) specifically teaches that such lenses provide equal laser energy densities at the machining spots, hence obtaining holes having a uniform size and shape.

9. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Nakazawa et al. (US Patent No. 5,948,200) in view of Funami et al. (US Patent No. 5,055,653) and in further view of Derwent 1988-159505.

Nakazawa *et al.* ('200) in view of Funami *et al.* ('653) teach the basic claimed process as described above.

Regarding claim 9, although Nakazawa et al. ('200) teaches a YAG laser Nakazawa et al. ('200) in view of Funami et al. ('653) do not teach a CO₂ laser. Derwent 1988-159505 teaches that CO₂ and Nd:YAG lasers are equivalent alternatives for laser drilling green ceramic sheets. Therefore, it would have been obvious for one of ordinary skill in the art to have used a CO₂ laser as an equivalent alternative to a YAG laser as taught by Derwent 1988-159505 in the process of Nakazawa et al. ('200) in view of Funami et al. ('653) because Derwent 1988-159505 specifically teaches that CO₂ and

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Nd:YAG lasers are equivalent alternatives for laser drilling green ceramic sheets, whereas Nakazawa *et al.* ('200) teaches a YAG laser and also because both Nakazawa *et al.* ('200) and Derwent 1988-159505 teach laser drilling of green ceramic sheets.

10. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Nakazawa et al. (US Patent No. 5,948,200) in view of JP 10-034365 and in further view of Funami et al. (US Patent No. 5,055,653) and Derwent 1988-159505.

Nakazawa et al. ('200) in view of JP 10-034365 and in further view of Funami et al. ('653) teach the basic claimed process as described above.

Regarding claim 9, although Nakazawa et al. ('200) teaches a YAG laser Nakazawa et al. ('200) in view of JP 10-034365 and in further view of Funami et al. ('653) do not teach a CO₂ laser. Derwent 1988-159505 teaches that CO₂ and Nd:YAG lasers are equivalent alternatives for laser drilling green ceramic sheets. Therefore, it would have been obvious for one of ordinary skill in the art to have used a CO₂ laser as an equivalent alternative to a YAG laser as taught by Derwent 1988-159505 in the process of Nakazawa et al. ('200) in view of JP 10-034365 and in further view of Funami et al. ('653) because Derwent 1988-159505 specifically teaches that CO₂ and Nd:YAG lasers are equivalent alternatives for laser drilling green ceramic sheets, whereas Nakazawa et al. ('200) teaches a YAG laser and also because both Nakazawa et al. ('200) and Derwent 1988-159505 teach laser drilling of green ceramic sheets.

Response to Arguments

11. Applicants' remarks filed February 20, 2003 (Paper No. 22) have been

considered.

In view of Applicants' explanatory remarks filed February 20, 2003 (Paper No.

22) that the purpose of filing the Declaration under 37 CFR 1.131 was to establish that

"the invention of US Patent No. 6,172,330 was NOT invented by 'another'", the

rejections over US Patent No. 6,172,330 has been withdrawn.

It should be noted that "although affidavits or declarations submitted for the

purpose of establishing that the reference discloses applicant's invention (emphasis

added) are properly filed under 37 CFR 1.132, rather than 37 CFR 1.131, such affidavits

submitted improperly under 37 CFR 1.131 will be considered as though they were filed

under 37 CFR 1.132 to traverse a ground of rejection. In re Facius, 408 F.2d 1396,

161 USPQ 294 (CCPA 1969)" (see MPEP §715.01(a)).

Conclusion

12. The prior art made of record and not relied upon is considered pertinent to

applicant's disclosure.

13. Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Stefan Staicovici, Ph.D. whose telephone number is (703)

305-0396. The examiner can normally be reached on Monday-Friday 8:00 AM to 5:30

PM and alternate Fridays off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Richard D. Crispino, can be reached at (703) 308-3853. The fax phone number for this Group is (703) 305-7718.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0661.

Stefan Staicovici, PhD

Primary Examiner

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March 7, 2003